CLF3H0035-100; CLF3H0035S-100 Broadband RF power GaN HEMT Rev. 1 — 23 December 2021

AMPLEON

Product data sheet

Product profile

1.1 General description

The CLF3H0035-100 and CLF3H0035S-100 are 100 W general purpose, unmatched broadband GaN HEMT transistors that are usable in the frequency range from DC to 3.5 GHz. The device utilizes a thermally enhanced package which supports both CW and pulsed applications.

Table 1. **Typical performance**

Typical RF performance at $T_{case} = 25$ °C; $V_{DS} = 50$ V; $I_{Dq} = 300$ mA; in a class-AB demo circuit, tested on straight lead device.

Test signal	f	P _{L(1dB)}	P _{L(3dB)}	G _p [1]	G _p [2]	G _p [3]	η _D [1]	η _D [2]	η _D [3]	η _D [4]	RL _{in} [5]	G _p [5]
	(MHz)	(W)	(W)	(dB)	(dB)	(dB)	(%)	(%)	(%)	(%)	(dB)	(dB)
pulsed CW [6]	500	75	100	14	-	15.8	72	-	67	73	-1	17.4
	1500	110	145	13.5	-	13.2	56	-	58	66	-3.8	15.4
	2500	90	110	14	-	15	50	-	48	50	-20	16.9
CW	500	70	102	-	14.3	15.5		69	64	72	-	-
	1500	90	135	-	12.5	12.5		53	53	64	-	-
	2500	75	102	-	13.5	14.4		46	44	47	-	-

- [1] At $P_L = 100 \text{ W}$.
- [2] At $P_L = 90 \text{ W}$.
- [3] At $P_L = P_{L(1dB)}$.
- [4] At $P_L = P_{L(3dB)}$.
- [5] Small signal.
- [6] $t_p = 100 \ \mu s; \ \delta = 30 \ \%.$

1.2 Features and benefits

- 100 W general purpose broadband RF power GaN HEMT
- High efficiency
- Low thermal resistance
- Excellent ruggedness
- Designed for broadband operation in the frequency range from DC to 3.5 GHz
- For RoHS compliance see the product details on the Ampleon website

2. Pinning information

Table 2. Pinning

Pin	Description		Simplified outline	Graphic symbol
CLF3H003	35-100 (SOT467C)			
1	drain			
2	gate		1	
3	source	[1]	2 3	2 → 3 3 amp01464
CLF3H003	35S-100 (SOT467B)			
1	drain			
2	gate		1	
3	source	[1]	- 3	2 → 3 3 amp01464

^[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Package name	Orderable part number	12NC	3	Min. orderable quantity (pieces)
SOT467C	CLF3H0035-100U	9349 602 87112	Tray; 20-fold; non-dry pack	20
SOT467B	CLF3H0035S-100U	9349 602 88112	Tray; 20-fold; non-dry pack	20

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	150	V
V_{GS}	gate-source voltage		-8	+2	V
I _{GF}	forward gate current		-	16	mA
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature	[1]	-	225	°C

^[1] Continuous use at maximum temperature will affect the reliability. For details refer to the online MTF calculator.

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R _{th(s-c)(IR)} [1]		$T_{case} = 81 ^{\circ}C; V_{DS} = 50 V; I_{Dq} = 160 mA;$ $P_{dis} = 85 W$	1.05	K/W
R _{th(ch-c)(FEA)} [2]	thermal resistance from active die channel to case by Finite Element Analysis	$T_{case} = 81 ^{\circ}C; V_{DS} = 50 V; I_{Dq} = 160 mA;$ $P_{dis} = 85 W$	1.6	K/W

- [1] Infrared (IR) thermal values are for reference only and cannot be used to determine performance or reliability.
- [2] Finite Element Analysis (FEA) thermal values have been used for the online MTF calculator.

6. Characteristics

Table 6. DC characteristics

 $T_{\rm case}$ = 25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{(BR)DSS}	drain-source breakdown voltage	$V_{GS} = -8 \text{ V}; I_D = 16 \text{ mA}$	150	-	-	V
V _{GS(th)}	gate-source threshold voltage	$V_{DS} = 6 \text{ V}; I_{D} = 160 \text{ mA}$	-	-2.9	-	V
I _{DSX}	drain cut-off current	V _{GS} = 2 V; V _{DS} = 6 V	-	12.5	-	Α
I _{GSS}	gate leakage current	V _{GS} = 11 V; V _{DS} = 6 V	-	-	140	nA
g _{fs}	forward transconductance	V _{GS} = 0 V; V _{DS} = 6 V	-	3.9	-	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = 0 \text{ V}; V_{DS} = 100 \text{ mV}$	-	240	-	mΩ

Table 7. AC characteristics

 $T_i = 25$ °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C _{iss}	input capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 50 \text{ V}; f = 1 \text{ MHz}$	-	19.8	-	pF
Coss	output capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 50 \text{ V}; f = 1 \text{ MHz}$	-	10.6	-	pF
C _{rss}	reverse transfer capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 50 \text{ V}; f = 1 \text{ MHz}$	-	0.84	-	pF

Table 8. RF characteristics

RF characteristics in Ampleon production test circuit; typical RF performance at $T_{\rm case}$ = 25 °C; $V_{\rm DS}$ = 50 V; $I_{\rm Dq}$ = 160 mA; $t_{\rm p}$ = 100 μ s; δ = 10 %; in a class-AB demo board, tested on straight lead device at a frequency of 2500 MHz.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
PL	output power	$P_L = P_{L(3dB)}$	-	118	-	W
Gp	power gain	P _L = 100 W	14	15	-	dB
η_{D}	drain efficiency	P _L = 100 W	52	57	-	%
RL _{in}	input return loss	P _L = 100 W	-	-12	-8	dB

7. Test information

7.1 Ruggedness in class-AB operation

The CLF3H0035-100 and CLF3H0035S-100 are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: $V_{DS} = 50 \text{ V}$; f = 1300 MHz at rated load power on RF development board using CW RF signal.

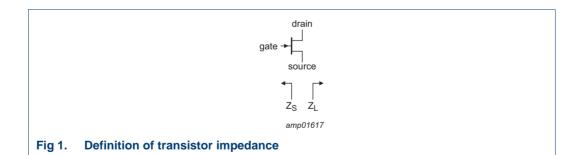
7.2 Impedance information

Table 9. Typical impedance

Measured load-pull data; pulsed CW, I_{Dq} = 320 mA; δ = 10 %; t_p = 100 μ s. Typical values unless otherwise specified.

f	Z _S [1]	Z _L [1]	Gp	ηρ	PL
(MHz)	(Ω)	(Ω)	(dB)	(%)	(W)
Maximu	m power load				
1000	1.21 + 1.63j	5.8 + 0.88j	20.0	64.5	174.5
2000	2.72 – 2.43j	6.1 – 0.38j	13.7	59.0	170.0
2500	1.93 – 6.62j	5.2 – 3.20j	12.8	57.0	160.0
3000	2.70 - 9.70j	5.9 – 4.80j	11.0	52.8	158.0
3500	5.50 – 16.0j	8.0 – 8.30j	10.6	46.5	155.0
Maximu	m drain efficien	cy load	<u>'</u>		
1000	1.21 + 1.63j	6.0 + 6.0j	21.5	78.0	124
2000	2.72 – 2.43j	4.7 + 4.3j	15.2	69.0	123
2500	1.93 – 6.62j	3.1 – 1.2j	14.2	63.6	124
3000	2.70 - 9.70j	3.9 – 2.8j	12.8	57.0	123
3500	5.50 – 16.0j	4.3 – 5.6j	12.1	53.0	121

[1] Z_S and Z_L defined in Figure 1.



7.3 Test circuit information

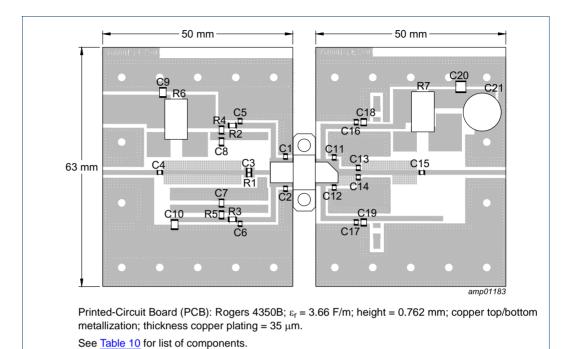
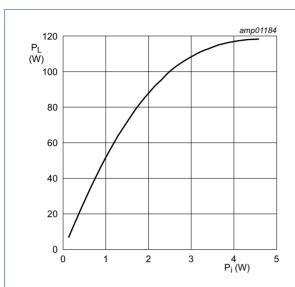


Fig 2. Component layout for production RF test circuit

Table 10. List of components For test circuit see Figure 2.

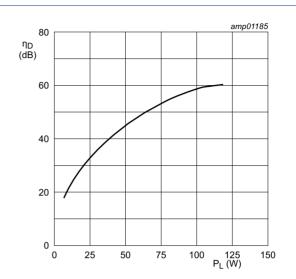
Component	Description	Value	Remarks
C1, C2	multilayer ceramic chip capacitor	1.9 pF	ATC 800A series
C3	multilayer ceramic chip capacitor	3 pF	ATC 800A series
C4, C15	multilayer ceramic chip capacitor	47 pF	ATC 800A series
C5, C6, C16, C17	multilayer ceramic chip capacitor	20 pF	ATC 800A series
C7, C8, C18, C19	multilayer ceramic chip capacitor	100 nF, 100 V	
C9, C10, C20	multilayer ceramic chip capacitor	$4.7~\mu\text{F},100~\text{V}$	
C11, C12	multilayer ceramic chip capacitor	2.7 pF	ATC 800A series
C13, C14	multilayer ceramic chip capacitor	0.9 pF	ATC 800A series
C21	electrolytic capacitor	$4.7~\mu\text{F},63~\text{V}$	
R1	resistor	100 Ω	SMD 0603
R2, R3	resistor	15 Ω	SMD 1206
R4, R5	resistor	10 Ω	SMD 1206
R6, R7	shunt resistor	10 mΩ	current monitoring

7.4 Graphical data



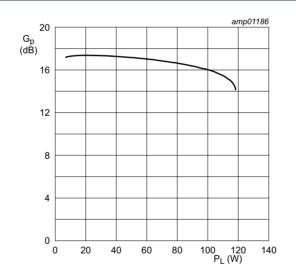
f = 2500 MHz; V_{DS} = 50 V; I_{Dq} = 160 mA; t_p = 100 μs ; δ = 10 %.

Fig 3. Output power as a function of input power; typical values



f = 2500 MHz; V_{DS} = 50 V; I_{Dq} = 160 mA; t_p = 100 $\mu s;$ δ = 10 %.

Fig 4. Drain efficiency as a function of output power; typical values



f = 1030 MHz; V_{DS} = 50 V; I_{Dq} = 160 mA; t_p = 100 $\mu s; \, \delta$ = 10 %.

Fig 5. Power gain as a function of output power; typical values

8. Package outline

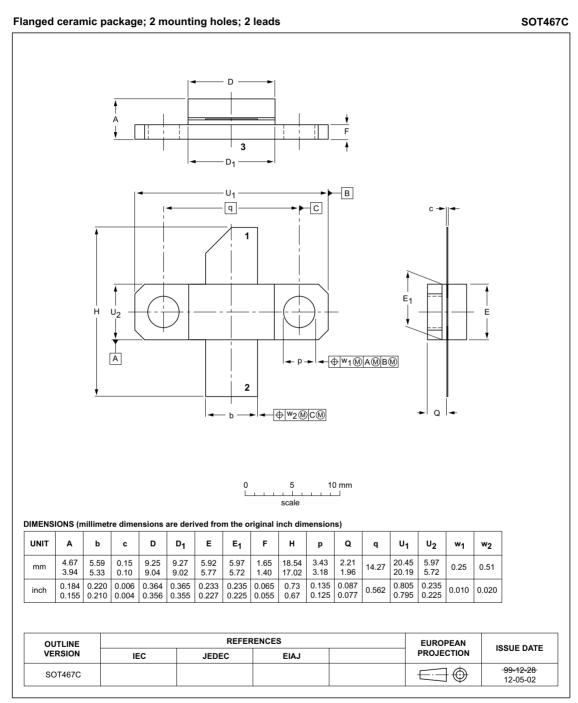


Fig 6. Package outline SOT467C

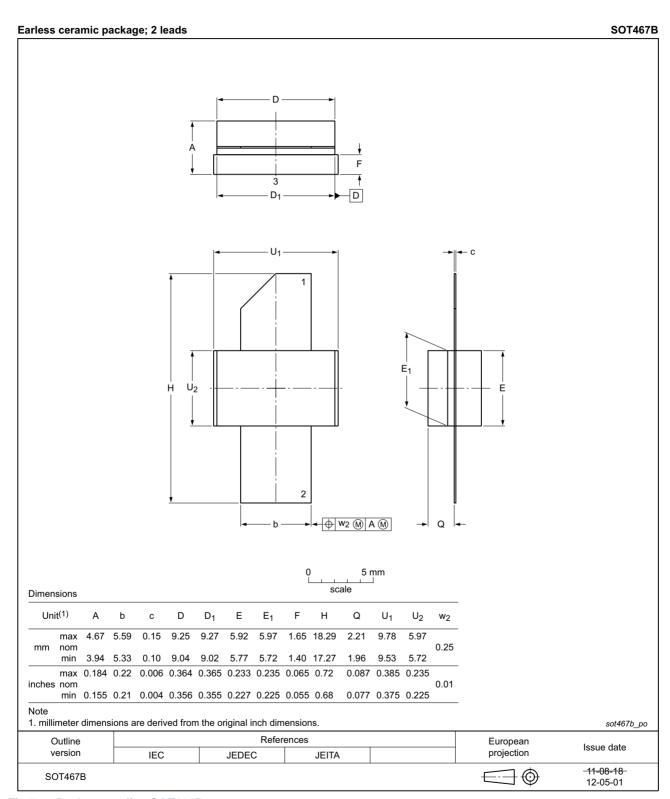


Fig 7. Package outline SOT467B

9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

Table 11. ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	C2B [1]
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	1A [2]

- [1] CDM classification C2B is granted to any part that passes after exposure to an ESD pulse of 750 V.
- [2] HBM classification 1A is granted to any part that passes after exposure to an ESD pulse of 250 V.

10. Abbreviations

Table 12. Abbreviations

Acronym	Description
CW	Continuous Wave
EMC	ElectroMagnetic Compatibility
ESD	ElectroStatic Discharge
GaN	Gallium Nitride
HEMT	High Electron Mobility Transistor
MTF	Median Time to Failure
SMD	Surface Mounted Device
RoHS	Restriction of Hazardous Substances
VSWR	Voltage Standing Wave Ratio
WiMAX	Worldwide Interoperability for Microwave Access

11. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
CLF3H0035-100_H0035S-100 v.1	20211223	Product data sheet	-	-

12. Legal information

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Document status[1][2]	Product status[3]	Definition
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Broadband RF power GaN HEMT

14. Contents

1	Product profile
1.1	General description 1
1.2	Features and benefits
2	Pinning information 2
3	Ordering information 2
4	Limiting values
5	Thermal characteristics 3
6	Characteristics
7	Test information 4
7.1	Ruggedness in class-AB operation 4
7.2	Impedance information 4
7.3	Test circuit information 5
7.4	Graphical data 6
8	Package outline
9	Handling information 9
10	Abbreviations9
11	Revision history 9
12	Legal information
12.1	Data sheet status
12.2	Definitions
12.3	Disclaimers
12.4	Trademarks11
13	Contact information 11
14	Contents

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